



3D Printing of MEMS Technology, 3rd Edition

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Message from the Guest Editor

Three-dimensional printing is one of the emerging technologies of our century. Since its first use in rapid prototyping, this technology has developed further towards rapid production, especially for complicated objects or small lot sizes. Nowadays, new 3D printing technologies enable printing even the smallest features at the micro- or even nanoscale. On the other hand, well-known problems, such as the waviness of fused deposition modeling (FDM)-printed parts, the lack of long-term stability of some typical printing materials, or the reduced mechanical properties of 3D-printed objects, still exist.

This Special Issue focuses on the 3D printing of MEMS technology, including various 3D printing techniques, and highlights the possibilities provided by recent technologies as well as the challenges which are still to be overcome. We now invite the most recent developments in this interdisciplinary research area for the third volume.





Editor-in-Chief

Message from the Editor-in-Chief

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